ASSOCIATION CONNECTION ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both This level	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and N	Afg Informat	tion		
upplier Inform	nation														
Company name*			Company unique ID			Ţ	Unique ID Authority				Respon	Response Date*			
nsemi											2024-0	2024-05-16			
Contact Name		Title - Contact			F	Phone - Contact*				Email ·	Email - Contact*				
Product-Env-Stew	ards		Product Enviro Compliance			]	NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			F	Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards Product E				act Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Request	er Item Number	Mfr Item Number Mfr Item Name  NCP189CMTWADJT NCP189 AD slew r AG		Mfr Item Name			Effective Date	e Vers	Version Manufacturing Site			Weight*	UOM	Unit Type	
				rate ADJ WDFNW6	5 2x2	2024-05-16 M		MY1		9.38	mg	Each			
<b>Ianufacturing</b>	Process Information	on													
Terminal Plating / Grid Array Material Termi			erminal Base Alloy J-STD-020 MSL R		I-STD-020 MSL Rati	ing	Peak Process Body Temperature Max Time at Pe		ure Max Time at Peal	ık Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed			CU Alloy 1		1		260	260 C 30		seconds 3					
omments															
vel 1 - maximum	time at peak temperature	during sol	dering is 10-3	0 seconds					·	·			·		
or more informat	ion regarding material co	mposition 1	please refer to	page 3	·									·	

RoHS Material Composition Declaration			Declaration Type *	Detail	led				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an						
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the company that the company tha	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the hts and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the				
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the				

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight 0.46	Unit of Measure	
Die	0.46	mg	Supplier	Silicon (Si)	7440-21-3			mg	
Die Attach	0.23	mg		Epoxy resin	proprietary data		0.0345	mg	
			Supplier	Silver (Ag)	7440-22-4		0.184	mg	
			Supplier	Bismaleimide	13676-54-5		0.0115	mg	
Lead Frame	2.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0462	mg	
			Supplier	Tin (Sn)	7440-31-5		0.1618	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.0051	mg	
			Supplier	Chromium (Cr)	7440-47-3		0.0076	mg	
			Supplier	Copper (Cu)	7440-50-8		2.4729	mg	
Mold Compound-Black	5.54	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		0.4155	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0277	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		4.4043	mg	
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.277	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.4155	mg	
Plating	0.4	mg	Supplier	Tin (Sn)	7440-31-5		0.4	mg	
Wire Bond - Cu	0.05	mg	Supplier	Palladium (Pd)	7440-05-3		0.001	mg	
			Supplier	Copper (Cu)	7440-50-8		0.049	mg	